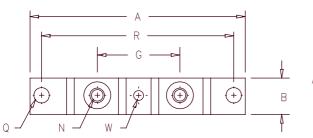
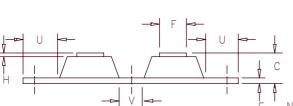
Schottky PowerMod









Baseplate



Notes: Baseplate: Nickel plated copper

Dim. In	ches	Millimeters		
Min.	Max.	Min.	Max.	Notes
	3.630 0.800 .680 0.130 0.510 BSC	 17.78 3.05 12.45 34.92		
H 0.050 N Q 0.275 R 3.150 U 0.600 V 0.312 W 0.180		1.25 6.99 80.0° 15.24 7.92 4.57	7.37 1 BSC 8.64 4.95	1/4-20 Dia.

Microsemi Catalog Number	Industry Part Number	J	Repetitive Peak Reverse Voltage
CPT60080*	MBR60080CT	80V	80V

90V CPT60090* 90V CPT600100* MBR600100CT 100V 100V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard ring protection
- 600 Amperes/ 80 to 100 Volts
- 175°C junction temperature
- Reverse energy tested
- ROHS Compliant

Electrical Characteristics

[F(AV) 600 Amps Average forward current per pkg (AV) 300 Amps Average forward current per leg IFSM 6000 Amps Maximum surge current per leg Maximum repetitive reverse current per leg |R(OV) 2 Amps
Max peak forward voltage per lea VFM 0.85 Volt 0.85 Volts Max peak forward voltage per leg 0.62 Volts VFM Max peak forward voltage per leg 75 mA ^IRM Max peak reverse current per leg ^IRM Max peak reverse current per leg 8.0 mA Typical junction capacitance per leg 9000 pF

 ^{T}C = 132°C, Square wave, $^{R}\Theta JC$ = 0.10°C/W ^{T}C = 132°C, Square wave, $^{R}\Theta JC$ = 0.20°C/W 8.3ms, half sine, ^{T}J = 175°C f = 1 KHZ, 25°C, 1µsec square wave |FM = 300A:TJ = 25°C |FM = 300A:TJ = 175°C $V_{RRM}, T_{J} = 125^{\circ}C^{*}$ VRRM, TJ = 25°C $V_R = 5.0V, T_C = 25^{\circ}C$

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range Operating junction temp range Max thermal resistance per leg Max thermal resistance per pkg Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

TSTG ΤJ R OJC R OJC Recs -55°C to 175°C -55°C to 175°C

 0.20°C/W Junction to case 0.10°C'/W Junction to case 0.08°C/W Case to sink 35-40 inch pounds 30-40 inch pounds 8-10 inch pounds

2.8 ounces (78 grams) typical



CPT60080 - CPT600100

Figure 1 Typical Forward Characteristics — Per Leg

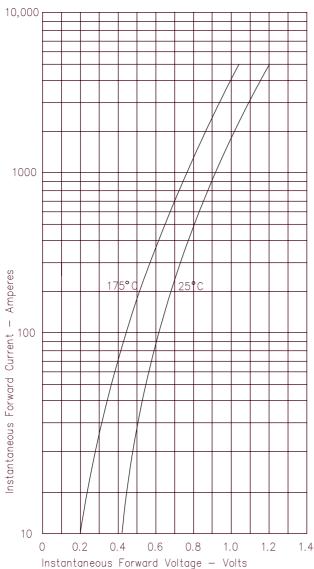


Figure 2 Typical Reverse Characteristics — Per Leg

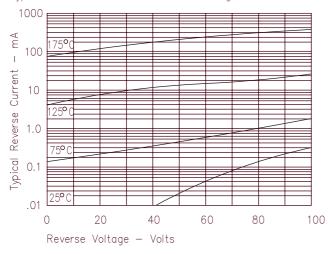


Figure 3 Typical Junction Capacitance — Per Leg

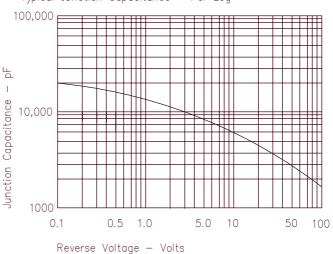


Figure 4
Forward Current Derating — Per Leg

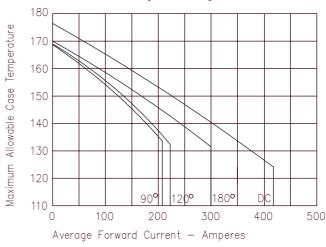
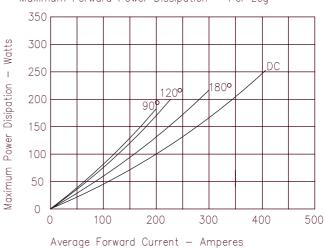


Figure 5
Maximum Forward Power Dissipation — Per Leg





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